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Vishay Siliconix

N-Channel 250 V (D-S) 175 °C MOSFET

| PRODUCT SUMMARY | | | | | |
|---------------------|----------------------------------|------|---------|--|--|
| V _{DS} (V) | Q _g (TYP.) | | | | |
| 250 | 0.031 at V _{GS} = 10 V | 63.5 | 57.6 nC | | |
| 230 | 0.032 at V _{GS} = 7.5 V | 62.5 | 37.0110 | | |



Ordering Information:

SUM10250E-GE3 (lead (Pb)-free and halogen-free)

FEATURES

- ThunderFET® power MOSFET
- Tuned for the lowest R_{DS}-C_{oss} FOM
- Maximum 175 °C junction temperature
- 100 % R_a and UIS tested
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



APPLICATIONS

- Power supplies:
 - Uninterruptible power supplies
 - AC/DC switch-mode power supplies
 - Lighting
- · Synchronous rectification
- DC/DC converter
- · Motor drive switch
- DC/AC inverter
- · Solar micro inverter

N-Channel MOSFET

| • | Class | D | audio | amr | olifier |
|---|-------|------------------|-------|-----|---------|
| _ | Olass | \boldsymbol{L} | audio | ann | |

| ABSOLUTE MAXIMUM RATINGS (| $\Gamma_{\rm C}$ = 25 °C, unless other | erwise noted) | | | |
|---|--|-----------------------------------|------------------|------|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | | |
| Drain-Source Voltage | | V _{DS} | 250 | .,, | |
| Gate-Source Voltage | | V _{GS} | ± 20 | V | |
| Continuous Drain Current (T _{.1} = 150 °C) | T _C = 25 °C | 1 | 63.5 | | |
| Continuous Drain Current (1) = 150 °C) | T _C = 70 °C | I _D | 36.6 | | |
| Pulsed Drain Current (t = 100 μs) | I _{DM} | 150 | A | | |
| Avalanche Current L = 0.1 mH | | I _{AS} | 60 | | |
| Single Avalanche Energy ^a | L = 0.1 IIIII | E _{AS} | 180 | mJ | |
| Maximum Davier Dissination 3 | T _C = 25 °C | Б | 375 ^b | W | |
| Maximum Power Dissipation ^a | T _C = 125 °C | P _D | 125 ^b | T vv | |
| Operating Junction and Storage Temperature Range | | T _J , T _{stg} | -55 to +175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | |
|--|-------------------|-------|------|--|
| PARAMETER | SYMBOL | LIMIT | UNIT | |
| Junction-to-Ambient (PCB mount) ^c | R _{thJA} | 40 | °C/W | |
| Junction-to-Case (Drain) | R _{thJC} | 0.4 | C/VV | |

Notes

- a. Duty cycle ≤ 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR4 material).



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| PARAMETER | SYMBOL | TEST CONDITIONS | MIN. | TYP. | MAX. | UNIT | |
|--|----------------------|---|------|--------|--------|------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage V _{DS} | | $V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$ | 250 | - | - | | |
| Gate Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 2 | - | 4 | V | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$ | - | - | ± 250 | nA | |
| | | V _{DS} = 250 V, V _{GS} = 0 V | - | - | 1 | μА | |
| Zero Gate Voltage Drain Current | I _{DSS} | V _{DS} = 250 V, V _{GS} = 0 V, T _J = 125 °C | - | - | 150 | | |
| | | V _{DS} = 250 V, V _{GS} = 0 V, T _J = 175 °C | - | - | 5 | mA | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$ | 90 | - | - | Α | |
| Drain-Source On-State Resistance a | D | $V_{GS} = 10 \text{ V}, I_D = 30 \text{ A}$ | - | 0.0247 | 0.0310 | 0 | |
| Drain-Source On-State Resistance | R _{DS(on)} | $V_{GS} = 7.5 \text{ V}, I_D = 30 \text{ A}$ | - | 0.0255 | 0.0320 | Ω | |
| Forward Transconductance ^a | g _{fs} | $V_{DS} = 15 \text{ V}, I_D = 30 \text{ A}$ | - | 63 | - | S | |
| Dynamic ^b | | | | | | | |
| Input Capacitance | C _{iss} | | - | 3002 | - | pF | |
| Output Capacitance | Coss | $V_{GS} = 0 \text{ V}, V_{DS} = 125 \text{ V}, f = 1 \text{ MHz}$ | - | 184 | - | | |
| Reverse Transfer Capacitance | C _{rss} | | - | 18 | - | | |
| Total Gate Charge ^c | Qg | | - | 57.6 | 88 | nC | |
| Gate-Source Charge ^c | Q_{gs} | $V_{DS} = 125 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 60 \text{ A}$ | - | 15.1 | - | | |
| Gate-Drain Charge ^c | Q_{gd} | | - | 18.4 | - | | |
| Gate Resistance | R_g | f = 1 MHz | 1.5 | 3.1 | 5 | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | - | 13 | 26 | | |
| Rise Time ^c | t _r | $V_{DD} = 125 \text{ V}, R_L = 2.08 \Omega$ | - | 93 | 180 | ns | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D\cong 60~A,~V_{GEN}=10~V,~R_g=1~\Omega$ | - | 30 | 60 | | |
| Fall Time ^c | t _f | | - | 72 | 144 | | |
| Drain-Source Body Diode Ratings ar | nd Characteri | stics ^b (T _C = 25 °C) | | | | | |
| Pulsed Current (t = 100 μs) | I _{SM} | | - | - | 100 | А | |
| Forward Voltage ^a | V_{SD} | I _F = 10 A, V _{GS} = 0 V | - | 0.79 | 1.2 | V | |
| Reverse Recovery Time | t _{rr} | | - | 212 | 420 | ns | |
| Peak Reverse Recovery Charge | I _{RM(REC)} | I _F = 30 A, di/dt = 100 A/µs | - | 14.5 | 29 | Α | |
| Reverse Recovery Charge Q _{rr} | | , | - | 1.6 | 3.2 | μC | |

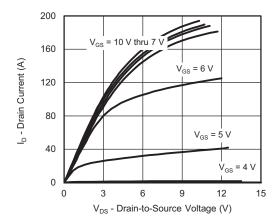
Notes

- a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

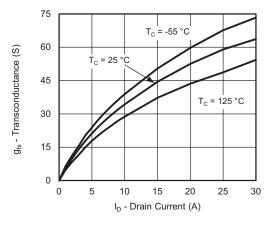
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



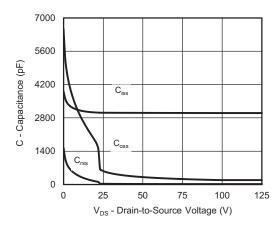
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



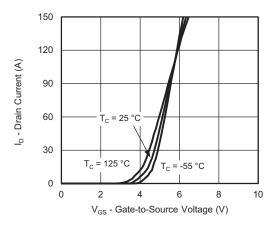
Output Characteristics



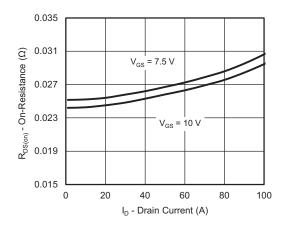
Transconductance



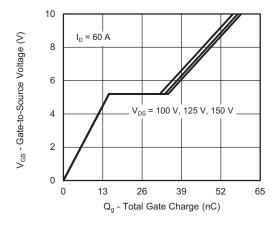
Capacitance



Transfer Characteristics



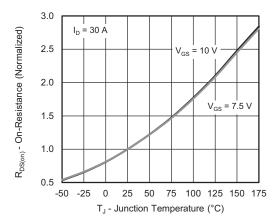
On-Resistance vs. Drain Current



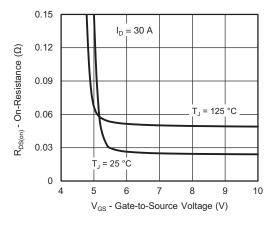
Gate Charge



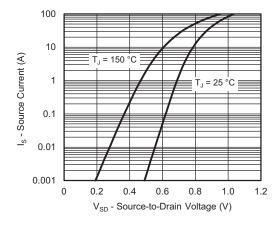
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



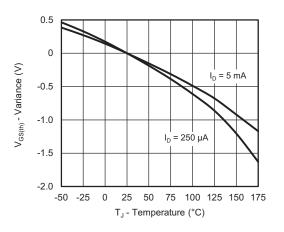
On-Resistance vs. Junction Temperature



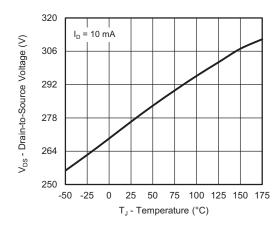
On-Resistance vs. Gate-to-Source Voltage



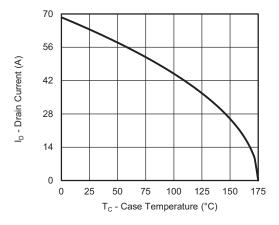
Source Drain Diode Forward Voltage



Threshold Voltage



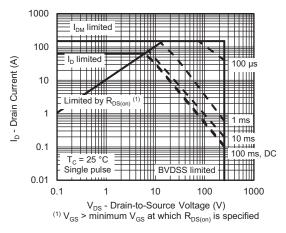
Drain Source Breakdown vs. Junction Temperature



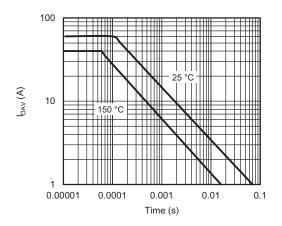
Current Derating



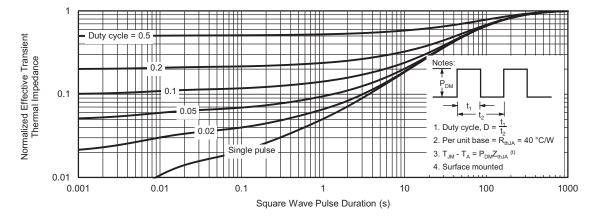
THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Safe Operating Area



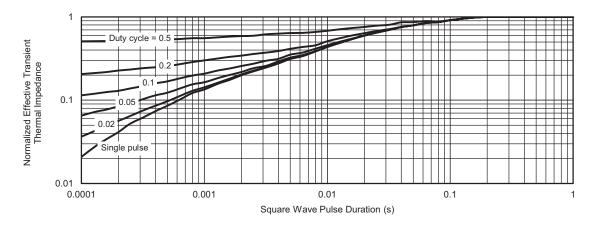
Single Pulse Avalanche Current Capability vs. Time



Normalized Thermal Transient Impedance, Junction-to-Ambient



THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg279026.



TO-263 (D²PAK): 3-LEAD









DETAIL A (ROTATED 90°)



| 1 | | 1 |
|----|---------|----------|
| ≥⊨ | 탕 | <u> </u> |
| | . ! | Ť |

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB. Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.

6. This feature is for thick lead.

| DIM. | | INC | HES | MILLIMETERS | | |
|---------------------------------|------------|-----------|-------|-------------|--------|--|
| | | MIN. | MAX. | MIN. | MAX. | |
| Α | | 0.160 | 0.190 | 4.064 | 4.826 | |
| | b | 0.020 | 0.039 | 0.508 | 0.990 | |
| | b1 | 0.020 | 0.035 | 0.508 | 0.889 | |
| | b2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| c* | Thin lead | 0.013 | 0.018 | 0.330 | 0.457 | |
| C | Thick lead | 0.023 | 0.028 | 0.584 | 0.711 | |
| c1 | Thin lead | 0.013 | 0.017 | 0.330 | 0.431 | |
| CI | Thick lead | 0.023 | 0.027 | 0.584 | 0.685 | |
| | c2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| | D | 0.340 | 0.380 | 8.636 | 9.652 | |
| | D1 | 0.220 | 0.240 | 5.588 | 6.096 | |
| | D2 | 0.038 | 0.042 | 0.965 | 1.067 | |
| | D3 | 0.045 | 0.055 | 1.143 | 1.397 | |
| | D4 | 0.044 | 0.052 | 1.118 | 1.321 | |
| | Е | 0.380 | 0.410 | 9.652 | 10.414 | |
| | E1 | 0.245 | - | 6.223 | = | |
| | E2 | 0.355 | 0.375 | 9.017 | 9.525 | |
| | E3 | 0.072 | 0.078 | 1.829 | 1.981 | |
| | е | 0.100 BSC | | 2.54 BSC | | |
| K | | 0.045 | 0.055 | 1.143 | 1.397 | |
| L | | 0.575 | 0.625 | 14.605 | 15.875 | |
| L1 | | 0.090 | 0.110 | 2.286 | 2.794 | |
| L2 | | 0.040 | 0.055 | 1.016 | 1.397 | |
| L3 | | 0.050 | 0.070 | 1.270 | 1.778 | |
| L4 | | 0.010 BSC | | 0.254 BSC | | |
| M | | - | 0.002 | - | 0.050 | |
| ECN: T13-0707-Rev. K, 30-Sep-13 | | | | | | |

DWG: 5843





RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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